

UMB10N FHA

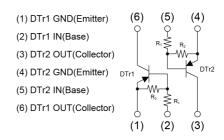
General purpose (Dual digital transistor)

AEC-Q101 Qualified

| Parameter | DTr1 and DTr2 | |
|----------------------|---------------|--|
| V _{CC} | -50V | |
| I _{C(MAX.)} | -100mA | |
| R ₁ | 2.2kΩ | |
| R ₂ | 47kΩ | |

• Outline SOT-363 SC-88 UMT6

Inner circuit



Features

- 1)Two DTA123J chips in a UMT6 package.
- 2)Mounting possible with UMT3 automatic mounting machines.
- 3)Transistor elements are independent, eliminating interference.
- 4)Mounting cost and area can be cut in half.

Application

INVERTER, INTERFACE, DRIVER

Packaging specifications

| Part No. | Package | Package size | Taping code | Reel size (mm) | Tape width (mm) | Basic ordering unit.(pcs) | Marking |
|------------|-------------------|-----------------|----------------|-------------------|--------------------|---------------------------------|---------|
| UMB10N FHA | SOT-363 (UMT6) | 2021 | TN | 180 | 8 | 3000 | B10 |

• Absolute maximum ratings (T_a = 25°C)

<For DTr1 and DTr2 in common>

| Parameter | Symbol | Values | Unit |
|------------------------------|--------------------------------|-------------|----------|
| Supply voltage | V _{CC} | -50 | V |
| Input voltage | V _{IN} | -12 to 5 | V |
| Output current | Ι _Ο | -100 | mA |
| Collector current | I _{C(MAX)} *1 | -100 | mA |
| Power dissipation | P _D ^{*2*3} | 150 | mW/TOTAL |
| Junction temperature | Tj | 150 | °C |
| Range of storage temperature | T _{stg} | -55 to +150 | °C |

• Electrical characteristics (T_a = 25°C)

<For DTr1 and DTr2 in common>

| Parameter | Sumbol | Conditions | Values | | | Unit | |
|----------------------|---------------------|---|--------|------|------|-------|--|
| | Symbol Conditions – | | Min. | Тур. | Max. | Offic | |
| Inputivaltage | V _{I(off)} | V _{CC} = -5V, I _O = -100µA | - | - | -0.5 | V | |
| Input voltage | V _{I(on)} | V _O = -0.3V, I _O = -5mA | -1.1 | - | - | v | |
| Output voltage | V _{O(on)} | I _O = -5mA, I _I = -0.25mA | - | -100 | -300 | mV | |
| Input current | I _I | V _I = -5V | - | - | -3.6 | mA | |
| Output current | I _{O(off)} | V _{CC} = -50V, V _I = 0V | - | - | -500 | nA | |
| DC current gain | Gı | V _O = -5V, I _O = -10mA | 80 | - | - | - | |
| Input resistance | R ₁ | - | 1.54 | 2.2 | 2.86 | kΩ | |
| Resistance ratio | R_2/R_1 | - | 17 | 21 | 26 | - | |
| Transition frequency | f _T *1 | V _{CE} = -10V, I _E = 5mA, f = 100MHz | - | 250 | - | MHz | |

*1 Characteristics of built-in transistor.

*2 Each terminal mounted on a reference land.

*3 120mW per element must not be exceeded.



•Electrical characteristic curves (T_a = 25°C) <For DTr1 and DTr2 in common>

Fig.1 Input Voltage vs. Output Current (ON Characteristics)

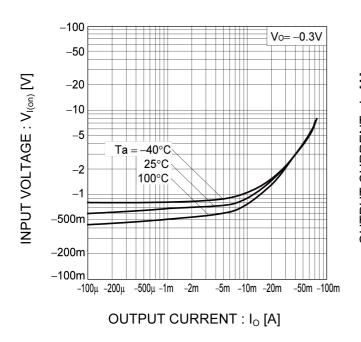


Fig.3 Output Current vs. Output Voltage

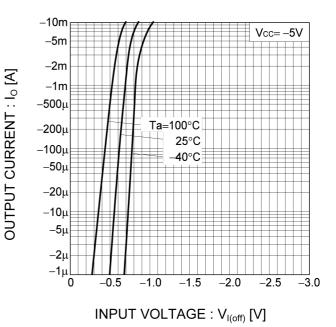
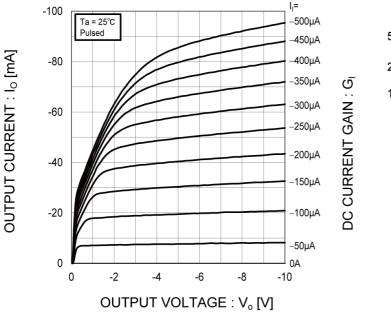
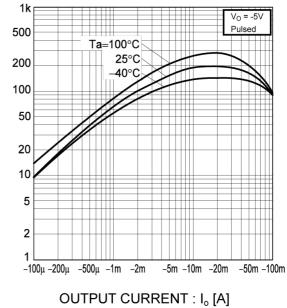


Fig.2 Output Current vs. Input Voltage (OFF Characteristics)

Fig.4 DC Current Gain vs. Output Current





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• Electrical characteristic curves ($T_a = 25^{\circ}C$)

<For DTr1 and DTr2 in common>

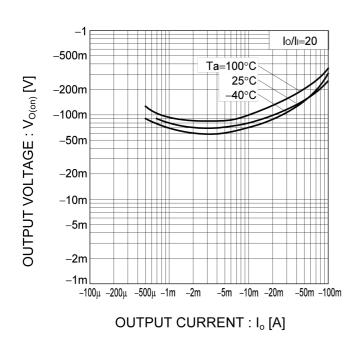
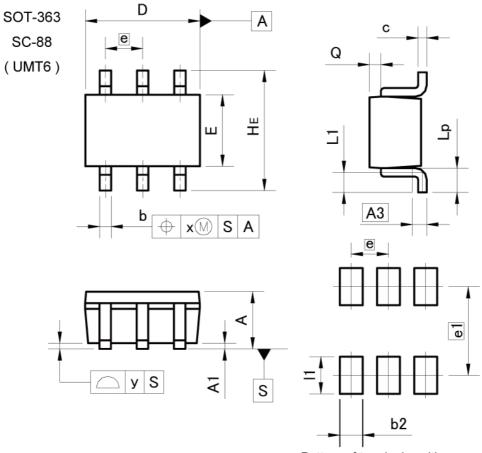


Fig.5 Output Voltage vs. Output Current



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Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

| DIM | MILIMETERS | | INC | HES | | |
|-----|------------|------|--------|-------|--|--|
| DIM | MIN | MAX | MIN | MAX | | |
| A | 0.80 | 1.00 | 0.031 | 0.039 | | |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 | | |
| A3 | 0.1 | 25 | 0.010 | | | |
| b | 0.15 | 0.30 | 0.006 | 0.012 | | |
| с | 0.10 | 0.20 | 0.004 | 0.008 | | |
| D | 1.90 | 2.10 | 0.075 | 0.083 | | |
| E | 1.15 | 1.35 | 0.045 | 0.053 | | |
| е | 0.65 | | 0.026 | | | |
| HE | 2.00 | 2.20 | 0.079 | 0.087 | | |
| L1 | 0.10 | 0.40 | 0.004 | 0.016 | | |
| Lp | 0.25 | 0.55 | 0.010 | 0.022 | | |
| Q | 0.10 | 0.30 | 0.004 | 0.012 | | |
| x | - | 0.10 | - | 0.004 | | |
| У | - | 0.10 | - | 0.004 | | |
| | | | | | | |
| DIM | MILIMETERS | | INCHES | | | |
| DIM | MIN | MAX | MIN | MAX | | |
| b2 | | 0.40 | - | 0.016 | | |
| e1 | . 1. | 55 | 0.061 | | | |
| 1 | - | 0.65 | - | 0.026 | | |

Dimension in mm/inches



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| (Note1) Medical Equipment Classification of the Specific Ap | pplications |
|---|-------------|
|---|-------------|

| JAPAN | USA | EU | CHINA |
|--------|-----------|------------|---------|
| CLASSI | CLASSⅢ | CLASS II b | CLASSII |
| CLASSⅣ | CLASS III | CLASSⅢ | CLASSII |

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- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
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 - [c] the Products are exposed to direct sunshine or condensation
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